

General Description

The AAT4681 SmartSwitch enables separate stand-alone AC adapter and PMU USB chargers to independently control a single low $R_{\text{DS(ON)}}$ power MOSFET between battery and system power output. A 20V version is available for multi-cell Li-ion applications and a 6V version is available for single-cell Li-ion applications.

The two P-channel power MOSFETs required in UMPC applications for controlling independent charger ICs can be consolidated to a single device, saving space and reducing cost. The single $20m\Omega$ P-channel device in the AAT4681/-1 has four times lower $R_{\text{DS}(\text{ON})}$ than the equivalent path resistance formed by two series devices.

Ordering options are available for multi-cell and single-cell Li-ion versions. For the single-cell application, a 6V device with dual independent gate control is available. For 2-cell and 3-cell applications a 20V ordinary P-channel device is available in the same package and pin configuration. Both devices are available in the TDFN-10L 3mm x 3mm package.

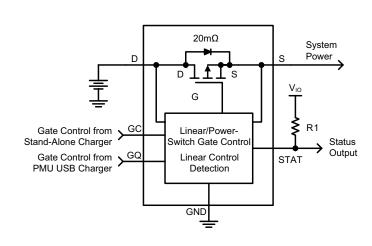
Features

- Multi-Cell 20V Device and Single-Cell 6V Device
- Dual Independent Gate Controls
 - Independent Linear Regulator and SMPS Power Switch States are Maintained
- 3mm x 3mm TDFN-10L package
- Temperature Range: -40°C to 85°C

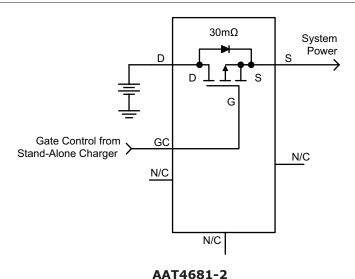
Applications

- Smart Phones
- Sub Notebooks
 - Smartbooks
 - Netbooks
- Ultra-Mobile PCs
- · Wireless Media Devices

Typical Application



AAT4681, AAT4681-1



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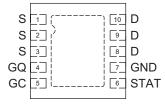
Pin Descriptions

	Pin N	lame		
Pin # AAT4681/-1		AAT4681-2	Function	
1, 2, 3	S	S	Source connection.	
4	GQ	N/C	Gate control from PMU charger.	
5	GC	GC	Gate control from stand-alone charger.	
6	STAT	N/C	Open drain status output. "STAT" signal "high" means QC is "on" and "STAT" signal low means GQ is "on"	
7	GND	N/C	Ground connection	
8, 9, 10	D	D	Drain connection.	

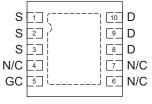
Pin Configuration

TDFN33-10L (Top View)

AAT4681/-1



AAT4681-2



Absolute Maximum Ratings¹

Symbol	Description	Value	Units	
AAT4681, AAT468	1-1			
V _D , V _S	Drain or Source Voltage to GND		6.0	V
V_{STAT}	STAT to GND		-0.3 to 6.0	V
I_{STAT}	STAT Current		10	mA
V _{GC} , V _{GQ}	Gate Voltage Levels to GND	Gate Voltage Levels to GND		
-	Continuous Drain Current @ T _A = 85°C	AAT4681	±7	А
I_{D}		AAT4681-1	±5	
I_{DM}	Pulsed Drain Current ²	Pulsed Drain Current ²		
I_{S}	Continuous Source Current (Source-Drain Diode	-1.5	Α	
AAT4681-2	· · · · · · · · · · · · · · · · · · ·			•
V _{DS}	Drain-Source Voltage	-20	V	
V_{GS}	Gate-Source Voltage	±12	V	
	Continuous Drain Current	$T_A = 25$ °C	±4.0	А
${ m I}_{ m D}$		T _A = 70°C	±3.2	А
I_{DM}	Pulsed Drain Current		±24	А
I_{S}	Continuous Source Current (Source-Drain Diode	-1.5	Α	

Thermal Characteristics³

Symbol	Description	Value	Units			
T _J	Operating Junction Temperature Range	-40 to +125	°C			
T _{LEAD}	Maximum Soldering Temperature (at leads, 10 sec.)	300	°C			
TDFN33-10L Thermal Impedance						
θ_{JA}	θ _{JA} Maximum Junction-to-Ambient Thermal Resistance		°C/W			
P _D	Maximum Power Dissipation ⁴	2	W			

¹ Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

^{2.} Pulse width $<300\mu s$, duty cycle <1%.

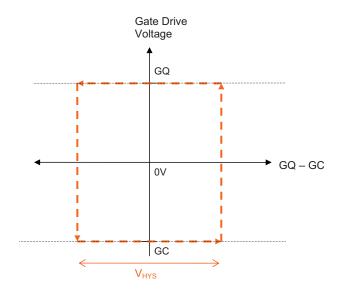
^{3.} T_3 is calculated from the ambient temperature T_A and power dissipation P_D according to the following formula: $T_3 = T_A + P_D \cdot \theta_{3A}$.

^{4.} Thermal Resistance is specified with approximately 1 square inch of 1 oz. copper.

Electrical Characteristics

 $T_A = -40$ °C to +85°C, unless otherwise noted. Typical values are at $T_A = +25$ °C.

Symbol	Description	n Conditions		Min	Тур	Max	Units		
AAT4681	AAT4681/-1								
V_{SYS}	Input Voltage Range ¹			1.8		5.5	V		
V_{UVLO}	Under-Voltage Lockout	For $V_{SYS} < V_{UVLO}$, GC active			1.4		V		
${ m I}_{ m Q}$	Quiescent Current	$V_D = 4.2V, T_J = 55^{\circ}C$			3.6	15	μΑ		
I_{DSS}	Drain-Source Leakage Current	$V_{GS} = 0V$, $V_{DS} = -5.5V$, $T_{J} = 55$ °C				-5	μΑ		
В	P-Channel On Resistance ²	$V_D = V_{GC} = 4.2V$, $V_{GQ} = GND$, $I_D = 5A$, $I_A = 25$ °C	AAT4681		18	25	mΩ		
R _{DS(on)}			AAT4681-1		23	28			
V_{HYS}	GQ-GC Transition Hysteresis	-GC Transition Hysteresis				300	mV		
t_{GSW}	GQ-GC Transition Delay	ransition Delay Slew rate of QG @ 1ms			10		μs		
$V_{STATLOW}$	STAT Logic Output Low $I_{STAT(SINK)} = 1mA$			0.025	0.4	V			
I _{STAT(SINK)}	STAT Logic High Leakage Current $V_{STAT} = 5.5V$, $V_{GC} = 5.5V$, $V_{GQ} = GND$			0.005	1	μΑ			
AAT4681-2									
BV _{DSS}	Drain-Source Breakdown Voltage $V_{GS} = 0V$, $I_D = -250\mu A$			-20			V		
R _{DS(ON)}	Drain-Source On-Resistance ² $V_{GS} = -4.5V$, $I_D = -4.0A$			27	40	mΩ			
$I_{D(ON)}$	On-State Drain Current	$V_{GS} = -4.5V$, $V_{DS} = -5V$ (pulse) ²		-24			Α		
$V_{GS(th)}$	Gate Threshold Voltage	Threshold Voltage $V_{GS} = V_{DS}$, $I_D = -250\mu A$			-0.8		V		

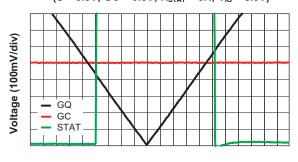


^{1.} Where V_{SYS} is the greater of V_D or V_S .

^{2.} Pulse width $< 300\mu s$, duty cycle < 1%.

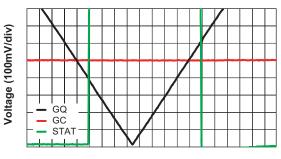
AAT4681/-1 Typical Electrical Characteristics

Hysteresis, GQ Ramp Time = 2.5ms (S = 5.5V; GC = 0.5V; R_{STAT} = 5K; V_{IO} = 5.5V)

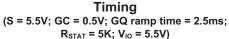


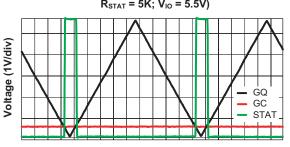
Time (100µs/div)

Hysteresis, GQ Ramp Time = 500μ s (S = 5.5V; GC = 0.5V; R_{STAT} = 5K; V_{IO} = 5.5V)



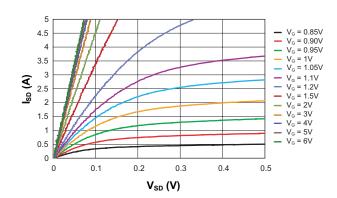
Time (20µs/div)



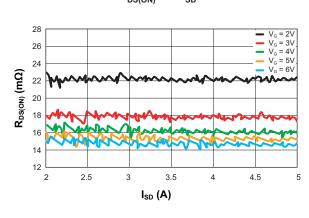


Time (1ms/div)

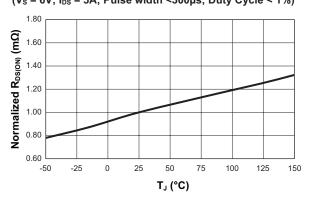
Shutdown Current vs. Shutdown Voltage



$R_{\text{DS(ON)}}$ vs. I_{SD}

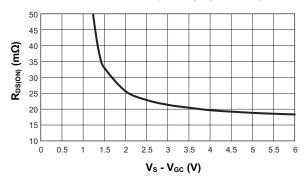


On-Resistance vs. Junction Temperature (Vs = 6V; I_{DS} = 5A; Pulse width <300µs; Duty Cycle < 1%)

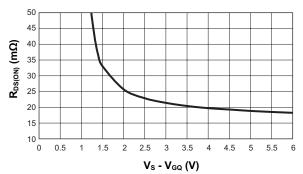


AAT4681/-1 Typical Electrical Characteristics

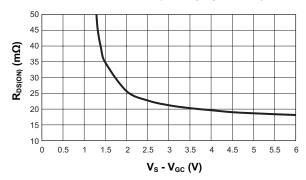
On-Resistance vs. Gate Voltage G_C ($V_S = 6V$; $V_{GQ} = 0V$, $I_{DS} = 5A$; Pulse Width < 300 μ s, Duty Cycle < 1%)



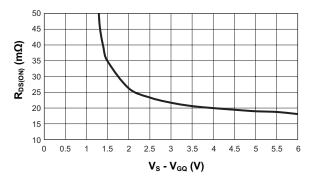
On-Resistance vs. Gate Voltage G_C $V_S = 6V$, $V_{GC} = 0V$, $I_{DS} = 5A$; Pulse Width < 300 μ s, Duty Cycle < 1%)



On-Resistance vs. Gate Voltage G_C $V_S = 6V$, $V_{GQ} = 0V$, $I_{DS} = 7A$; Pulse Width < 300 μ s, Duty Cycle < 1%)



On-Resistance vs. Gate Voltage G_Q $V_S = 6V$, $V_{GQ} = 0V$, $I_{DS} = 7A$; Pulse Width < 300 μ s, Duty Cycle < 1%)

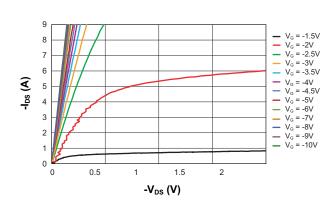


AAT4681

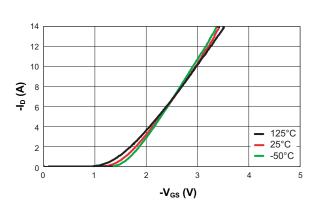
$20m\Omega$ P-Channel SmartSwitch for UMPC Battery Charging Applications

AAT4681-2 Typical Electrical Characteristics

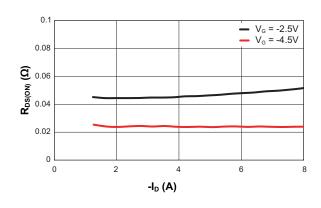
Output Characteristics



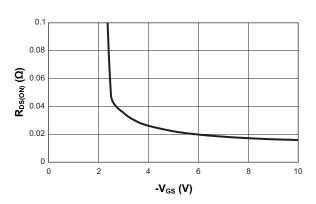
Transfer Characteristics



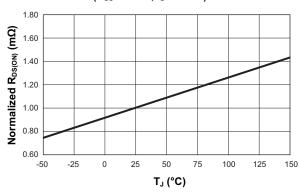
On-Resistance vs. Drain Current



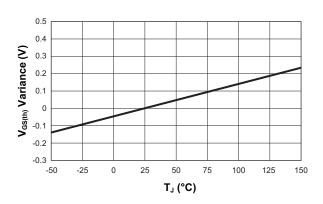
On-Resistance vs. Gate-Source Voltage



On-Resistance vs. Junction Temperature (V_{GS} = -4.5V; I_D = -5.9A)



Threshold Voltage vs. Junction Temperature

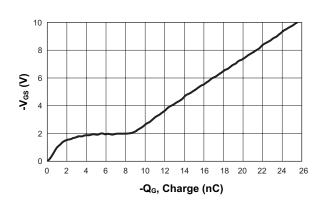


AAT4681

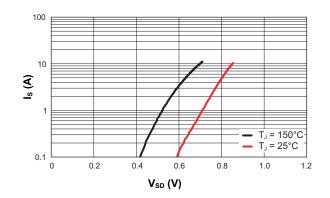
20mΩ P-Channel SmartSwitch for UMPC Battery Charging Applications

AAT4681-2 Typical Electrical Characteristics

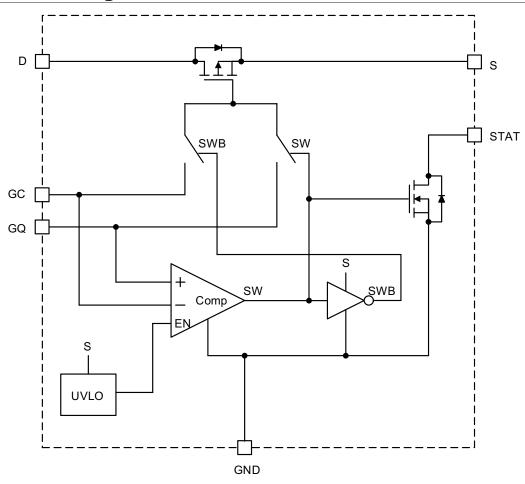
Gate Charge



Source-Drain Diode Forward Voltage



Functional Block Diagram



GC (Gate Control from Stand-Alone Charger)	GQ (Gate Control from PMU USB Charger)	P-Ch Gate Voltage Control Source
Vin	Vin	GC
Linear	0V	GC
0V*	Linear	GQ
0V	0V	GC
float	float	GC

^{*}Switch to GQ when GQ > GC even if QC is not equal to zero.

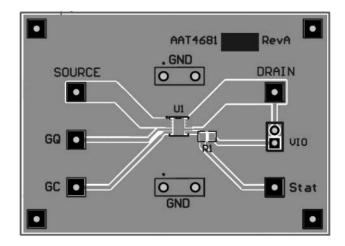


Figure 1: AAT4681IDE Evaluation Board Top Side Layout.

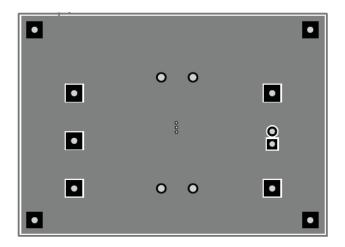


Figure 2: AAT4681IDE Evaluation Board Bottom Side Layout

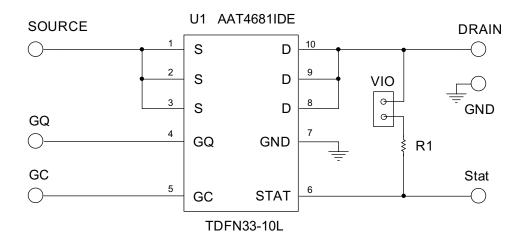


Figure 3: AAT4681IDE Evaluation Board Schematic.

Ordering Information

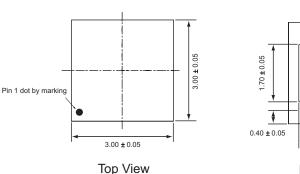
Package	Marking ¹	Continuous Drain Current (A)	Part Number (Tape and Reel) ²
TDFN33-10L	J8XYY	±7.0 ³	AAT4681IDE-T1
TDFN33-10L	F5XYY	±5.0 ³	AAT4681IDE-1-T1
TDFN33-10L	Y4XYY	±3.2 ⁴	AAT4681IDE-2-T1

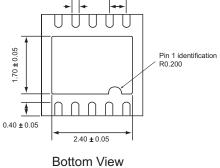


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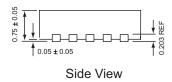
Package Information

TDFN33-10L⁵





0.23 + 0.05 0.500 BSC



All dimensions in millimeters.

^{1.} XYY = assembly and date code.

^{2.} Sample stock is generally held on part numbers listed in **BOLD**.

^{3.} T_A = 85°C.

^{4.} $T_A = 70^{\circ}C$

^{5.} The leadless package family, which includes QFN, TQFN, DFN, TDFN and STDFN, has exposed copper (unplated) at the end of the lead terminals due to the manufacturing process. A solder fillet at the exposed copper edge cannot be guaranteed and is not required to ensure a proper bottom solder connection.

DATA SHEET

AAT4681

$20m\Omega$ P-Channel SmartSwitch for UMPC Battery Charging Applications

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